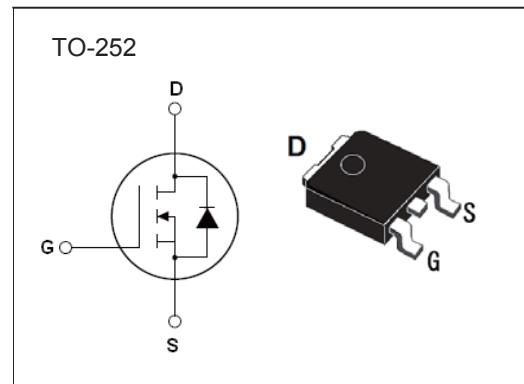


N-Channel MOSFET

2KK5068

■ Features

- $BV_{DSS} = 80 \text{ V}$
- $I_D = 60 \text{ A}$
- $R_{DS(\text{ON})} = 6.8 \text{ m}\Omega (\text{Typ.}) @ V_{GS} = 10 \text{ V}$
 $< 8.5 \text{ m}\Omega (\text{Max.}) @ V_{GS} = 10 \text{ V}$
- Special process technology for high ESD capability
- Special designed for Convertors and power controls
- High density cell design for ultra low $R_{DS(on)}$
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high EAs
- Excellent package for good heat dissipation

■ Absolute Maximum Ratings($T_c=25^\circ\text{C}$)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	80	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	60	A
		42	
Pulsed Drain Current (Note 1)	I_{DM}	310	
Peak Diode Recovery Voltage	dV/dt	30	V/ns
Single Pulse Avalanche Energy (Note 2)	EAS	300	mJ
Power Dissipation	P_D	140	W
Thermal Resistance. Junction- to- Case	R_{JC}	1.05	$^\circ\text{C}/\text{W}$
Thermal Resistance. Junction- to- Ambient	R_{JA}	50	
Junction Temperature	T_J	175	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to 175	

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. EAS condition: $T_J=25^\circ\text{C}, V_{DD}=37.5\text{V}, V_G=10\text{V}, L=0.5\text{mH}$

N-Channel MOSFET

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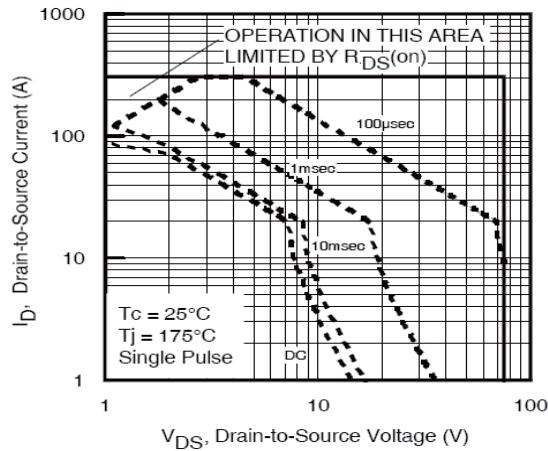
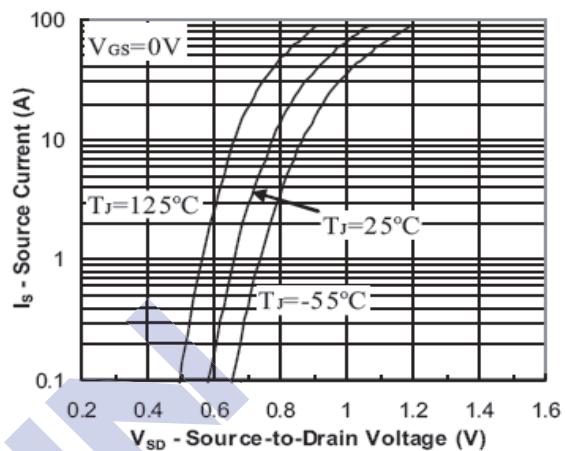
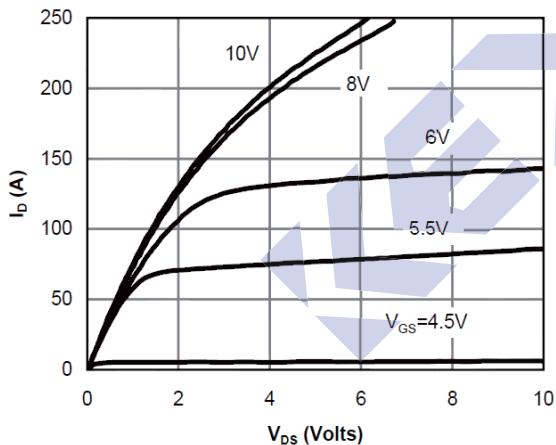
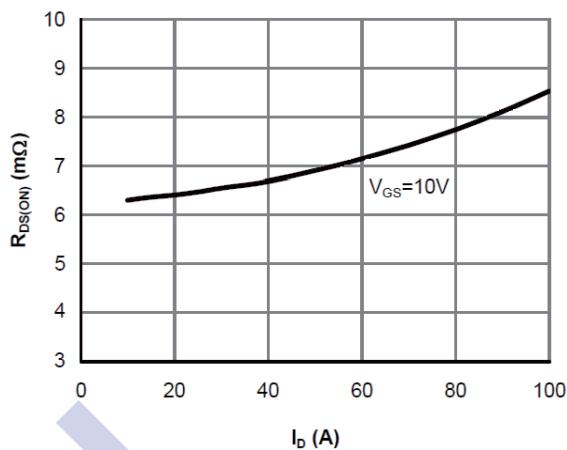
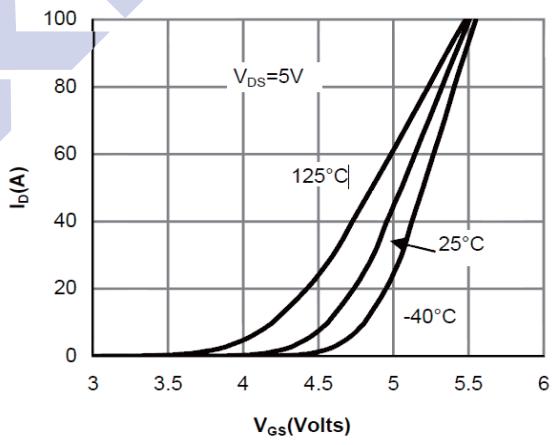
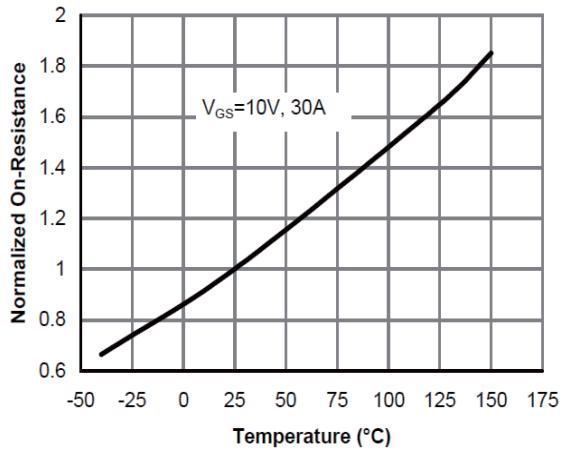
■ Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)

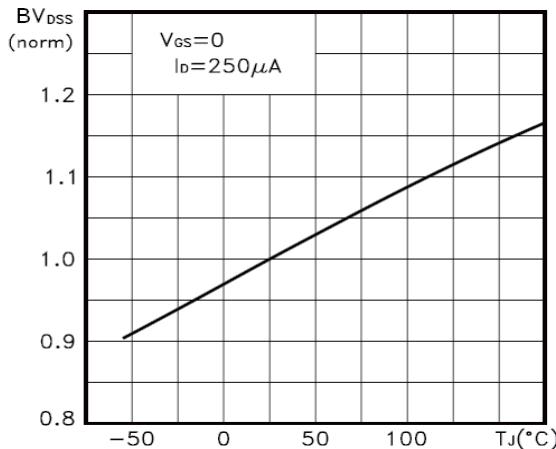
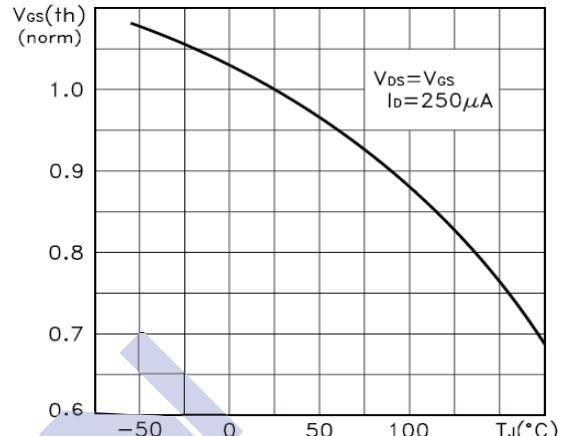
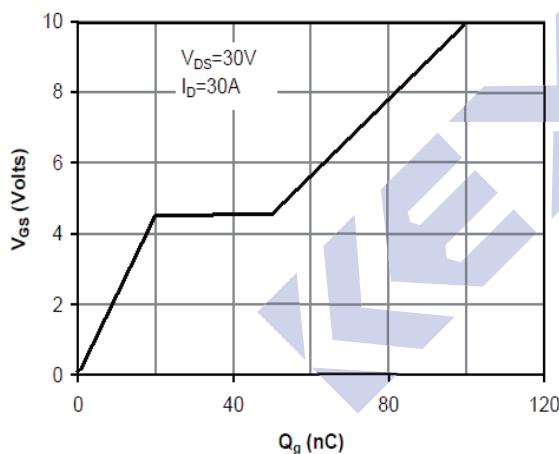
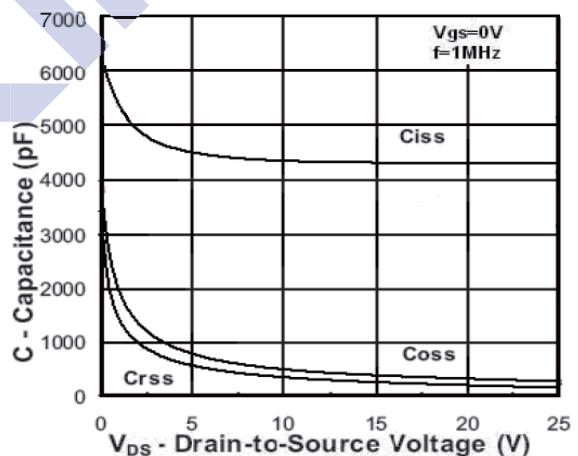
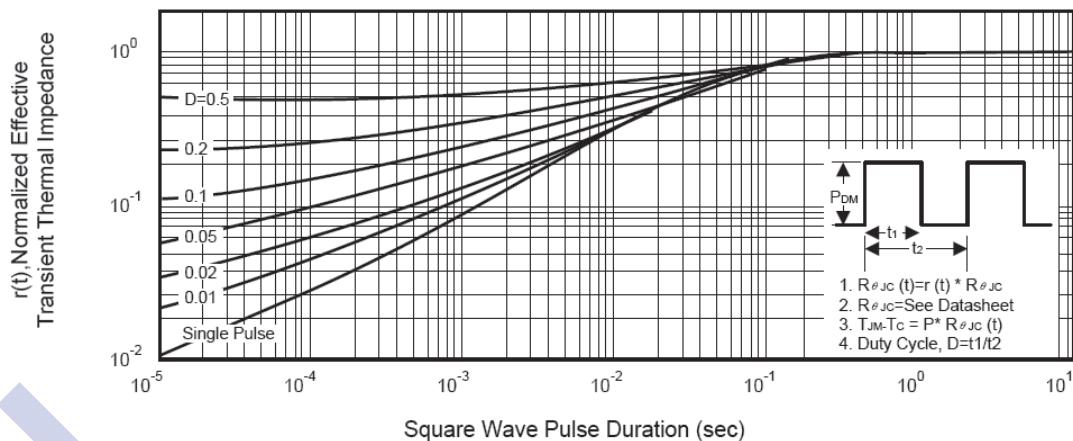
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250 \mu\text{A}, V_{GS} = 0\text{V}$	80			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_c = 125^\circ\text{C}$			10	
Gate to Source Leakage Current	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Gate to Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		6.8	8.5	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{DS} = 5 \text{ V}, I_D = 30 \text{ A}$		66		S
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		4400		pF
Output Capacitance	C_{oss}			340		
Reverse Transfer Capacitance	C_{rss}			260		
Total Gate Charge	Q_g	$V_{GS} = 10 \text{ V}, V_{DS} = 30 \text{ V}, I_D = 30 \text{ A}$		100		nC
Gate Source Charge	Q_{gs}			20		
Gate Drain Charge	Q_{gd}			30		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=30\text{V}, I_D=2\text{A}, R_L=15\Omega, V_{GS}=10\text{V}, R_G=2.5\Omega$		17.8		ns
Turn-On Rise Time	t_r			11.8		
Turn-Off Delay Time	$t_{d(off)}$			56		
Turn-Off Fall Time	t_f			14.6		
Source-drain current(Body Diode)	I_{SD}				80	A
Pulsed Source-drain current(Body Diode)	I_{SDM}				320	
Diode Forward Voltage (Note 1)	V_{SD}	$T_j=25^\circ\text{C}, I_{SD}=30\text{A}, V_{GS}=0\text{V}$			1.2	V
Reverse Recovery Time (Note 1)	t_{rr}	$T_j=25^\circ\text{C}, I_F=75\text{A}, dI/dt=100\text{A}/\mu\text{s}$			36	ns
Reverse Recovery Charge (Note 1)	Q_{rr}				56	nC

Note 1.Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 1.5\%$, $R_G=25\Omega$, Starting $T_j=25^\circ\text{C}$

■ Marking

Marking	K5068
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N-Channel MOSFET**2KK5068****■ Typical Electrical and Thermal Characteristics****Figure1. Safe operating area****Figure2. Source-Drain Diode Forward Voltage****Figure3. Output characteristics****Figure5. Static drain-source on resistance****Figure4. Transfer characteristics****Figure6. $R_{DS(\text{ON})}$ vs Junction Temperature**

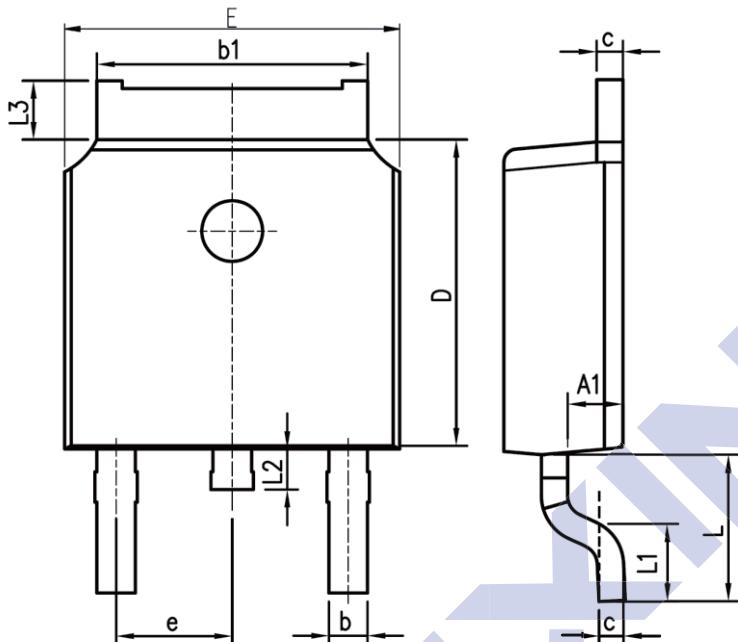
N-Channel MOSFET**2KK5068****Figure7. BV_{DSS} vs Junction Temperature****Figure8. $V_{GS(th)}$ vs Junction Temperature****Figure9. Gate charge waveforms****Figure10. Capacitance****Figure11. Normalized Maximum Transient Thermal Impedance**

N-Channel MOSFET

2KK5068

■ Package Outline Dimensions

Unit:mm



SYMBOL	mm	
	MIN	MAX
A	2.10	2.50
A1	0.97	1.17
b	0.63	0.93
b1	5.13	5.53
c	0.40	0.60
D	5.80	6.40
E	6.30	6.90
e	2.286BSC	
L	2.50	3.30
L1	1.20	1.80
L2	0.60	1.00
L3	0.85	1.30

